

OLED DISPLAY MODULE

Product Specification

CUSTOMER	Standard	
PRODUCT NUMBER	DD-2C16WE-1A	
CUSTOMER APPROVAL		Date

INTERNAL APPROVALS					
Product Mgr Doc. Control Electr. Eng					
Bazile	Bazile	Luo			
Peter	Peter	Luo			



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REVISION RECORD

Rev.	Date	Page	Chapt.	Comment	ECR no.
A	01 Feb 11			First Issue	
В	28 Nov 12	36	10	Update the part number	

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1 MAIN FEATURES

ITEM	CONTENTS
Characters x lines	16 x 2
Character Font	5 x 8
Overall Dimensions	68.50 x 17.50 x 2.00 mm
Colour	Monochrome White
Active Area	56.22 x 11.52 mm
Viewing Area	58.22 x 13.52 mm
Display Mode	Passive Matrix (2.26")
Driving Method	1/16 duty
Driver IC	US2066
Operating temperature	-40 ~ +70
Storage temperature	-40 ~ +85

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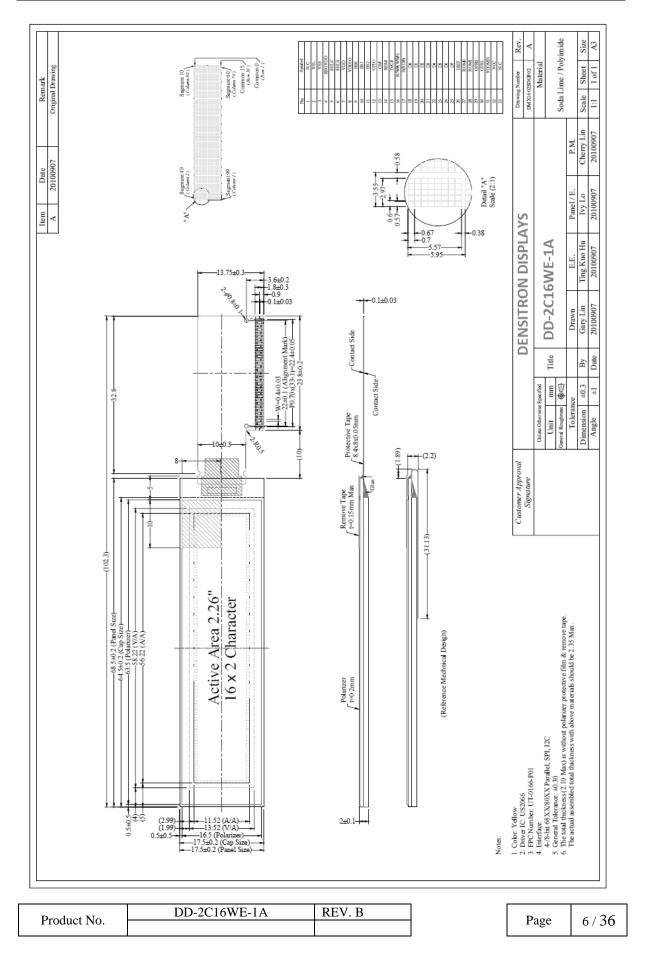


2 MECHANICAL SPECIFICATION

2.1 MECHANICAL CHARACTERISTICS

ITEM	CHARACTERISTIC	UNIT
Characters x lines	16 x 2	
Overall Dimensions	68.50 x 17.50 x 2.00	mm
Viewing Area	58.22 x 13.52	mm
Active Area	56.22 x 11.52	mm
Dot Size	0.57 x 0.67	mm
Dot Pitch	0.60 x 0.70	mm
Character size	2.97 x 5.57	mm
Weight	8.81	g
IC Controller/Driver	US2066	

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3 ELECTRICAL SPECIFICATION

3.1 ABSOLUTE MAXIMUM RATINGS

	I	1	1	VSS =	0 V, Ta = 25
Item	Symbol	Min	Max	Unit	Note
Supply Voltage for logic	V _{DD}	-0.3	5.5	V	Note 1, 2
Supply voltage for Display	Vcc	0	13	V	Note 1, 2
Operating Temperature	Тор	-40	70	°C	
Storage Temperature	Tst	-40	85	°C	

Note 1: All the above voltages are on the basis of "VSS=0V".

Note 2: When this module is used beyond the above absolute maximum ratings, permanent damage to the module may occur. Also for normal operations it's desirable to use this module under the conditions according to Section 3.2 "Electrical Characteristics". If this module is used beyond these conditions the module may malfunction and the reliability could deteriorate.

3.2 ELECTRICAL CHARACTERISTICS

Characteristics	Symbol	Conditions	Min	Тур	Max	Unit
	N	Internal Regulator Enable(output)	-	3.3	-	V
Supply Voltage for Logic	V _{DD}	Internal Regulator Disable(input)	2.4	-	3.6	V
See the Velke of few VO	N	5V Voltage Mode	4.4	-	5.5	V
Supply Voltage for I/O	V _{DDIO}	Low Voltage Mode	2.4	-	3.6	V
Supply Voltage for Display	V _{CC}	Note 1	7	12	12.5	V
High Level Input	V _{IH}	-	0.8xV _{DDIO}	-	V _{DDIO}	V
Low Level Input	V _{IL}	_	0	-	0.2 x VDDIO	V
High Level Output	V _{OH}	IOUT=0.1mA,	0.9 x VDDIO	-	Vddio	V
Low Level Output	V _{OL}	3.3MHz	0	-	0.1 x Vddio	V
Operating current for VDD	Idd	-	-	180	300	μΑ
One section of a symposite for Mar	Ing	Note 2	-	16	21	
Operating current for Vcc	Icc	Note 3	-	27	32	mA
Sleep mode current for VDD	Idd sleep		-	1	10	μΑ
Sleep mode current for Vcc	ICC SLEEP		-	2	10	μΑ

Note 1: Brightness (Lbr) and Supply Voltage for Display (VCC), are subject to the change of the panel characteristics

Note 2: $V_{DD} = 2.8V$, $V_{CC} = 12.0V$, 30% display area turned on.

Note 3: $V_{DD} = 2.8V$, $V_{CC} = 12.0V$, 100% display area turned on.

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3.3 INTERFACE PIN ASSIGNMENT

No.	Symbol	I/O	Function			
1	N.C.(GND)	-	Reserved Pin (Supporting Pin) The supporting pin can reduce the influence from stress on the function pins. This pin must be connected to external ground			
2	VSL	Р	Segment Voltage Reference Pin When external VSL is not used, this pin should be left open. When external VSL is used, connect with resistor and diode to ground.			
3	VSS	Р	Ground of Logic Circuit This is a ground pin. It also acts as a reference for the logic pins, the OEL driving voltages and the analogue circuits. It must be connected to external ground.			
4	REGVDD	Ι	Internal VDD Regulator Selection PinWhen this pin is pulled HIGH, internal VDD regulator is enabled (VDD outputs 3.3V).When this pin is pulled LOW, internal VDD regulator is disabled (VDD outputs 5V).			
5	SHLC	Ι	COM Scan Direction Selection This pin is used to determine the Common output scanning direction SHLC COM scan direction 0 COM0 to COM31 1 COM31 to COM0			
6	SHLS	Ι	SEG Direction Selection This pin is used to determine the SEG direction SHLS SEG direction 0 SEG99 to SEG0 1 SEG0 to SEG99			
7	VDD	Р	 Power Supply for Logic This is a voltage supply pin. It can be supplied externally or regulated internally. In 3V IO mode, this is a power input pin. In 5V IO mode, the output is around 3.3V. A capacitor should be connected between VDD and VSS under all circumstances 			
8	VDDIO	Р	Power Supply for Interface Logic Level It should match with the MCU interface voltage level and must be connected to external source			
9	BS0		Communicating Protocol Select These pins are MCU interface selection input. See the following table:			
10	BS1	Ι	BS0BS1BS2Serial Interface00Invalid10I2C01			

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			Invalid	1	1	0	
			8 bit 68XX-parallel	0	0	1	
11	BS2		4 bit 68XX-parallel	1	0	1	
			8 bit 80XX-parallel	0	1	1	
			4 bit 80XX-parallel	1	1	1	
12	GPIO	I/O	It is a reserved pin and is reco	mmended to	o keep it floa	ating.	
13	CS#	I	Chip Select This pin is the chip select inpu communication only when CS			or MCU	
14	RES#	Ι	Power Reset for Controller an This pin is reset signal input. of the chip is executed.		n is low, ini	tializatio	n
15	D/C#	Ι	Data/Command ControlThis is Data/Command control pin. When the pin is pulled high, the input at D7~D0 is treated as display data. When the pin is pulled low, the input at D7~D0 will be transferred to the command register. For detail relationship to MCU interface signals, please refer to the Timing Characteristics Diagrams.When the pin is pulled high and serial interface mode is selected, the data at SDIN is treated as data. When it is pulled low the data at SDIN will be transferred to the command register. In I2C mode, this pin acts as SA0 for slave address selection.				ed,
16	R/W#	Ι	Read/Write Select or Write This pin is MCU interface input. When interfacing to a 68XX-series microprocessor, this pin will be used as Read/Write (R/W#) selection input. Pull this pin to "High" for read mode and pull it to "Low" for write mode. When 80XX interface mode is selected, this pin will be the Write (WR#) input. Data write operation is initiated when this pin and the CS# are pulled low.				
17	E/RD#	Ι	Read/Write Enable or Read This pin is MCU interface input. When interfacing to a 68XX-series microprocessor, this pin will be used as the Enable (E) signal. Read/write operation is initiated when this pi is pulled high and the CS# is pulled low. When connecting to an 80XX-microprocessor, this pin receives the Read (RD#) signal. Data read operation is initiated when the				s
18~25	D0~D7	I/O	 pin is pulled low and CS# is pulled low. Host Data Input/Output Bus These pins are 8-bit bi-directional data bus to be connected to the microprocessor's data bus. When serial mode is selected, D1 will be the serial data input SDIN and D0 will be the serial clock input SCLK. When I2C mode is selected, D2, D1 should be tied together and serve as SDAout, SDAin in application and D0 is the serial clock input SCL 				vill ed

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AYS

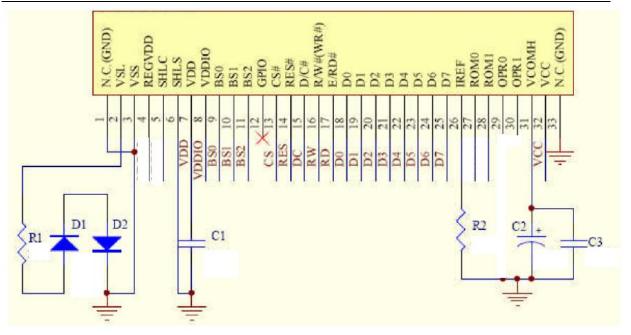
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26	IREF	Ι	Current Reference for Brightness Adjustment This pin is segment current reference pin. A resistor should be connected between this pin and VSS. Set the current at 12.5uA.				
27	ROM0		Character ROM Selection These pins are used to select Character ROM. See the following table: ROM ROM0				
28	ROM1	Ι	A 0 0 B 1 0 C 0 1 S/W selectable 1 1				
29	OPR0		Select the number of Character GeneratorThese pins are used to select Character number of charactergenerator. See the following table:CGROMCGRAMOPR0OPR1				
30	OPR1	I	$\begin{array}{c ccccccccccccccccccccccccccccccccccc$				
31	VCOMH	0	Voltage Output High Level for COM Signal This pin is the input pin for the voltage output high level for COM signals. A capacitor should be connected between this pin and VSS.				
32	VCC	Р	Power Supply for OEL Panel This is the most positive voltage supply pin of the chip. A stabilization capacitor should be connected between this pin and VSS when the converter is used. It must be supplied externally.				
33	N.C.	-	Reserved Pin (Supporting Pin) The supporting pin can reduce the influence from stress on the function pins. This pin must be connected to external ground				

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3.4 BLOCK DIAGRAM



Internal Regulator Selection:REGVDDCOM & SEG Direction Selection:SHLC and SHLSMCU Interface Selection:BS0, BS1 and BS2Character ROM SelectionROM0 and ROM1Character Generator SelectionOPR0 and OPR1

Pins connected to MCU interface: CS#, RES#, D/C#, R/W#, E/RD#, and D0~D7

C1, C3: 0.1μ F C2: 4.7μ F D1, D2: 1N4148 R1: 51R R2: $470k\Omega$, R1 = (Voltage at IREF – VSS) / IREF

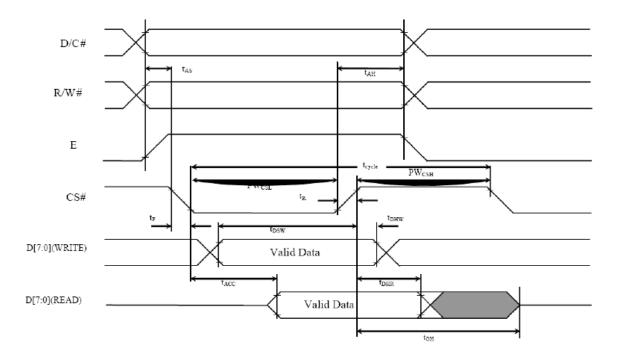
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3.5 TIMING CHARACTERISTICS

3.5.1 AC CHARACTERISTICS

3.5.1.1 68XX-Series MPU Parallel Interface Timing Characteristics

	VDD-VSS	$VDD-VSS = 1.65V \text{ to } 3.3V, Ta = 25^{\circ}C$				
Symbol	Description	Min	Max	Unit		
tcycle	System Cycle Time	400	-	ns		
t _{AS}	Address Setup Time	13	-	ns		
t _{AH}	Address Hold Time	17	-	ns		
t _{DSW}	Write Data Setup Time	35	-	ns		
t _{DHW}	Write Data Hold Time	18	-	ns		
t _{DHR}	Read Data Hold Time	13	-	ns		
t _{OH}	Output Disable Time	10	90	ns		
t _{ACC}	Access Time	-	125	ns		
DW	Chip Select Low Pulse Width (Read) Chip Select	250				
PW_{CSL}	Low Pulse width (Write)	50	1 -	ns		
	Chip Select High Pulse Width (Read) Chip Select	155				
PW_{CSH}	High Pulse Width (Write)	55	1 -	ns		
t _R	Rise Time	-	15	ns		
t _F	Fall Time	-	15	ns		

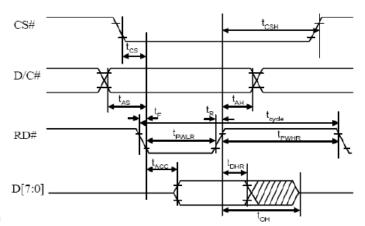


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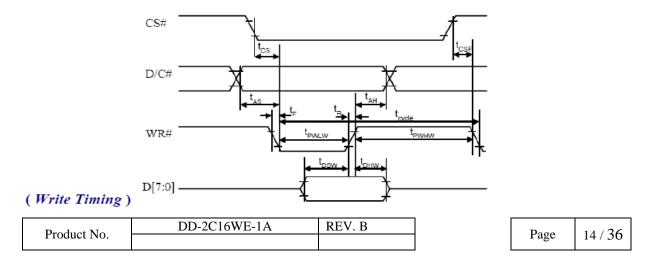


	VDD-VS	S = 1.65V	$a = 25^{\circ}C$	
Symbol	Description	Min	Max	Unit
tcycle	Clock Cycle Time	400	-	ns
t _{AS}	Address Setup Time	13	-	ns
t _{AH}	Address Hold Time	17	-	ns
t _{DSW}	Write Data Setup Time	35	-	ns
t _{DHW}	Write Data Hold Time	18	-	ns
t _{DHR}	Read Data Hold Time	13	-	ns
t _{OH}	Output Disable Time	10	70	ns
t _{ACC}	Access Time	-	125	ns
t _{PWLR}	Read Low Time	250	-	ns
t _{PWLW}	Write Low Time	50	-	ns
t _{PWHR}	Read High Time	155	-	ns
t _{PWHW}	Write High Time	55	-	ns
t _{CS}	Chip Select Setup Time	0	-	ns
t _{CSH}	Chip Select Hold Time to Read Signal	0	-	ns
t _{CSF}	Chip Select Hold Time	0	-	ns
t _R	Rise Time	-	15	ns
t _F	Fall Time	-	15	ns

3.5.1.2 8080-Series MPU Parallel Interface Timing Characteristics



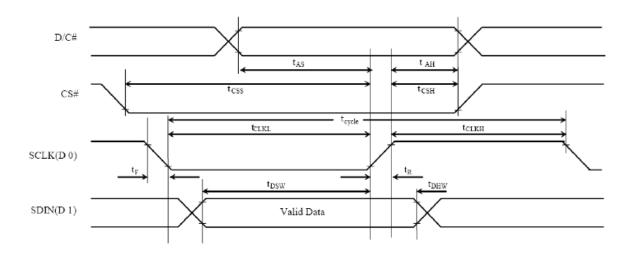
(Read Timing)

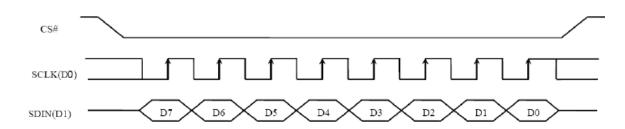




	VDD-VSS = 1.65V to 3.3V, Ta =			= 25°C
Symbol	Description	Min	Max	Unit
tcycle	Clock Cycle Time	1,000	20,000	ns
t _{AS}	Address Setup Time	60	-	ns
t _{AH}	Address Hold Time	20	-	ns
t _{CSS}	Chip Select Setup Time	60	-	ns
t _{CSH}	Chip Select Hold Time	20	-	ns
t _{DSW}	Write Data Setup Time	60	-	ns
t _{DHW}	Write Data Hold Time	20	-	ns
t _{CLKL}	Serial Clock Low Time	400	-	ns
t _{CLKH}	Serial Clock High Time	400	-	ns
t _R	Rise Time	-	15	ns
t _F	Fall Time	-	15	ns

3.5.1.3 Serial Interface Timing Characteristics



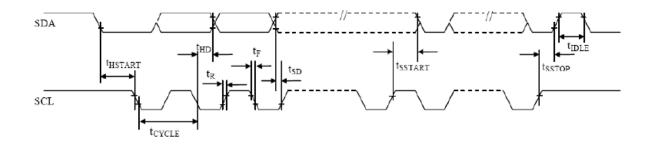


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	VDD-VSS	= 1.65 V to	3.3V, Ta =	= 25°C
Symbol	Description	Min	Max	Unit
tcycle	Clock Cycle Time	2.5	-	us
t _{HSTART}	Start Condition Hold Time	0.6	-	us
	Data Hold Time (for "SDAOUT" Pin) Data	5		
t _{HD}	Hold Time (for "SDAIN" Pin)	300	-	ns
t _{SD}	Data Setup Time	100	-	ns
t _{SSTART}	Start Condition Setup Time (Only relevant for a repeated Start condition)	0.6	-	us
t _{SSTOP}	Stop Condition Setup Time	0.6	-	us
t _R	Rise Time for Data and Clock Pin		300	ns
t _F	Fall Time for Data and Clock Pin		300	ns
t _{IDLE}	Idle Time before a New Transmission can Start	1.3	-	us

3.5.1.4 I²C Interface Timing Characteristics



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4 OPTICAL SPECIFICATION

4.1 OPTICAL CHARACTERISTICS

Characteristics	Symbol	Condition	Min	Тур	Max	Unit
Brightness	L _{br}	Note 1	120	150	-	cd/m ²
CLE (White)	(X)	C I E 1021	0.25	0.29	0.33	
C.I.E.(White)	(Y)	C.I.E. 1931	0.27	0.31	0.35	-
Dark Room Contrast	CR		-	>10,000:1	_	-
Viewing Angle			-	Free	-	degree

Optical measurement taken at $V_{DD} = 2.8V$, $V_{CC} = 7.25V$. Software configuration follows Section 5.4 Initialization

Note 1 Brightness (Lbr) and Supply Voltage for Display (Vcc) are subject to the change of the panel characteristics and the customers request

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5 FUNCTIONAL SPECIFICATION

5.1 COMMANDS

Please refer to the Technical Manual for the US2066

5.2 POWER UP/DOWN SEQUENCE

To protect panel and extend the panel lifetime, the driver IC power up/down routine should include a delay period between high voltage and low voltage power sources during turn on/off. It gives the panel enough time to complete the action of charge and discharge before/after the operation.

5.2.1 POWER UP SEQUENCE

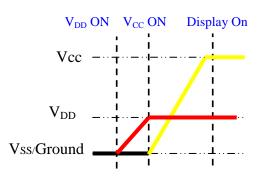
- 1. Power up V_{DD}
- 2. Send Display off command
- 3. Initialization
- 4. Clear Screen
- 5. Power up Vcc
- 6. Delay 100ms

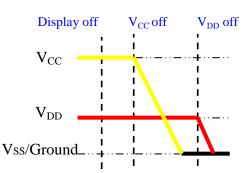
(When Vcc is stable)

7. Send Display on command

5.2.2 POWER DOWN SEQUENCE

- 1. Send Display off command
- 2. Power down V_{CC}
- 3. Delay 100ms
 (When V_{cc} reaches 0 and panel is Completely discharged)
- 4. Power down V_{DD}





Conditions:

1) Since an ESD protection circuit is connected between VDD and VCC inside the driver IC, VCC becomes lower than VDD whenever VDD is ON and VCC is OFF. 2) VCC should be kept float (disable) when it is OFF.

3) Power Pins (VDD, VCC) can never be pulled to ground under any circumstance.4) VDD should not be power down before VCC power down.7

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5.3 RESET CIRCUIT

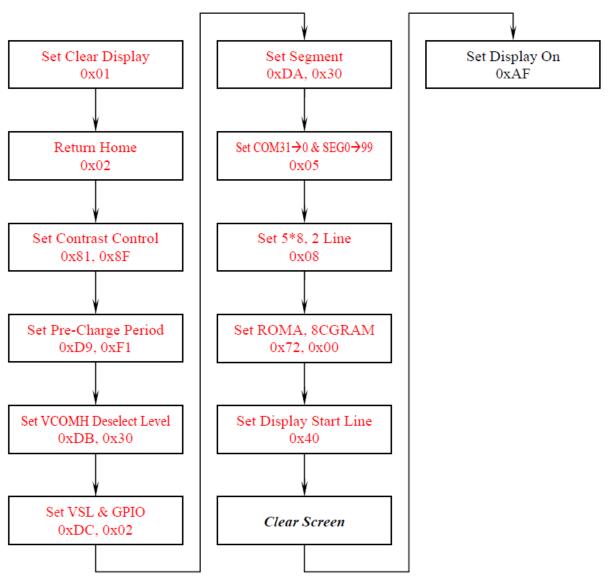
When RES# input is low, the chip is initialized with the following status:

- 1. Display is off, Cursor off, Blink off
- 2. Power down off
- 3. 5-dot font is default
- 4. Display shift disable
- 5. CGRAM address is 00h. SEGRAM address is 00h
- 6. DDRAM address is 00H.
- 7. Display start line is set at display RAM address 0
- 8. Column address counter is set at 0
- 9. Normal scan direction of the COM outputs
- 10. Contrast control register is set at 7FH

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5.4 ACTUAL APPLICATION EXAMPLE

Command usage and explanation of an actual example <Initialisation Setting>



If the noise is accidentally occurred at the displaying window during the operation, please reset the display in order to recover the display function.

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5.5 US2066 CGROM CHARACTER CODE

5.5.1 ROMA

b3-0	0000	0001	0010	0011	0100	0101	0110	0111	1000	1001	1010	1011	1100	1101	11 10	11 11	
0000																	
0001																	
0010																	
0011																	
0100																	
0101																	
0110																	
0111																	
1000																	
1001																	
1010																	
1011																	
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Produ	ict No).		DI	D-2C1	6WE	E-1A		R	EV. B	5					Pag	e



5.5.2 ROMB

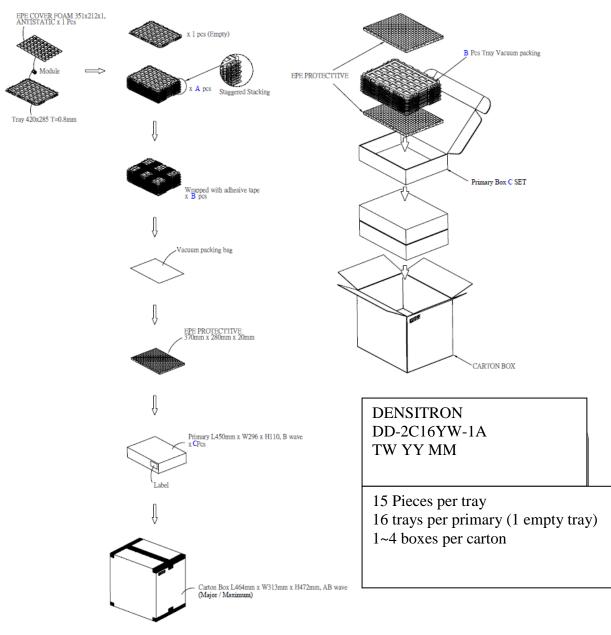
b3-0		 													
b7-4		 0010			0101		0111	1000	1001	1010	1011	 11 01	11 10		
0000															
0001															
0010															
0011															
0100															
0101															
0110															
0111															
1000															
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5.5.3 ROMC

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6 PACKAGING AND LABELLING SPECIFICATION



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7 QUALITY ASSURANCE SPECIFICATION

7.1 CONFORMITY

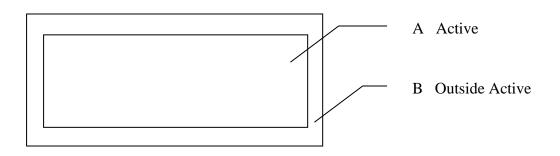
The performance, function and reliability of the shipped products conform to the Product Specification.

7.2 DELIVERY ASSURANCE

7.2.1 DELIVERY INSPECTION STANDARDS

IPC-AA610, class 2 electronic assemblies standard

7.2.2 Zone definition



7.2.3 Visual inspection

Test and measurement to be conducted under following conditions :

Temperature:	23±5°C
Humidity: Fluorescent lamp:	55±15%RH 30 W
Distance between the Panel & Eyes of the Inspector:	≧30cm
Distance between the Panel & the lamp:	≧50cm
Finger glove (or finger cover) must be worn by the inspector Inspection table or jig must be anti-electrostatic	or.

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7.2.4 Standard of appearance inspection

Partition	AQL	Definition
Major	0.65	Defects in Pattern Check (Display On)
Minor	1.0	Defects in Cosmetic Check (Display Off)

Check Item	Classification	Criteria
Panel General Chipping	Minor	X > 6 mm (Along with Edge) Y > 1 mm (Perpendicular to edge)

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Check Item	Classification	Criteria
Panel Crack	Minor	Any crack is not allowable.
Cupper Exposed (Even Pin or Film)	Minor	Not Allowable by Naked Eye Inspection
Film or Trace Damage	Minor	
Terminal Lead Twist	Minor	Not Allowable
Terminal Lead Broken	Minor	Not Allowable
Terminal Lead Prober Mark	Acceptable	
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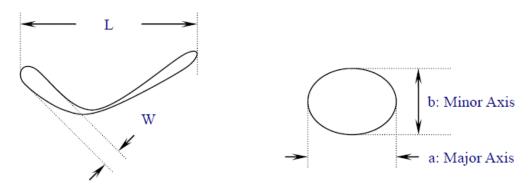
Check Item	Classification	Criteria
Terminal Lead Bent	Minor	NG if any bent lead cause lead shorting.
(Not Twist or Broken)	Minor	NG for horizontally bent lead more than 50% of its width.
Glue or Contamination on Pin (Couldn't Be Removed by Alcohol)	Minor	
Ink Marking on Back Side of panel (Exclude on Film)	Acceptable	Ignore for Any

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Check Item	Classification	Criteria	
Any Dirt & Scratch on Polarizer's Protective Film	Acceptable	Ignore for not Affe Polarizer	ect the
Scratches, Fiber, Line-Shape Defect (On Polarizer)	Minor	$W>0.1,L\leq 2$	Ignore $n \le 1$ n = 0
Dirt, Black Spot, Foreign Material, (On Polarizer)	Minor	$0.1 < \!\!\Phi \le 0.25$	Ignore $n \le 1$ n = 0
Dent, Bubbles, White spot (Any Transparent Spot on Polarizer)	Minor	Φ ≤ 0.5 → Ignore if no Influ Display 0.5 < Φ	nence on $n = 0$
Fingerprint, Flow Mark (On Polarizer)	Minor	Not Allowable	e

* Protective film should not be tear off when cosmetic check.

** Definition of W & L & Φ (Unit: mm): $\Phi = (a + b) / 2$



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Check	Item	Classificatio	n Criteria
No Di	splay	Major	
Flic	ker	Major	Not Allowable
Missin	g Line	Major	
Pixel	Short	Major	
Darker	Pixel	Major	
Wrong J	Display	Major	
Un-un	iform	Major	
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7.3 DEALING WITH CUSTOMER COMPLAINTS

7.3.1 Non-conforming analysis

Purchaser should supply Densitron with detailed data of non-conforming sample. After accepting it, Densitron should complete the analysis in two weeks from receiving the sample.

If the analysis cannot be completed on time, Densitron must inform the purchaser.

7.3.2 Handling of non-conforming displays

If any non-conforming displays are found during customer acceptance inspection which Densitron is clearly responsible for, return them to Densitron.

Both Densitron and customer should analyse the reason and discuss the handling of nonconforming displays when the reason is not clear.

Equally, both sides should discuss and come to agreement for issues pertaining to modification of Densitron quality assurance standard.

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8 RELIABILITY SPECIFICATION

8.1 RELIABILITY TESTS

Test Item	Test Condition	Evaluation and assessment		
High Temperature Operation	70°C, 240 hours	No abnormalities in function and appearance		
Low Temperature Operation	-40°C, 240 hours	No abnormalities in function and appearance		
High Temperature Storage	85°C, 240 hours	No abnormalities in function and appearance		
Low Temperature Storage	-40°C, 240 hours	No abnormalities in function and appearance		
High Temperature & High Humidity Storage	60°C, 90%RH, 120 hours	No abnormalities in function and appearance		
Thermal Shock	24 cycle of -40°C 1 Hour, 85°C 1 Hour. 60 Mins dwell	No abnormalities in function and appearance		

• The samples used for above tests do not include polarizer.

• No moisture condensation is observed during tests.

8.1.1 FAILURE CHECK STANDARD

After the completion of the described reliability test, the samples were left at room temperature for 2 hrs prior to conducting the failure teat at 23 ± 5 °C; $55\pm15\%$ RH

8.2 LIFE TIME

Item	Description
1	Function, performance, appearance, etc. shall be free from remarkable deterioration more than 30,000 hours under 120 cd/m ² brightness and 50% Checkerboard, humidity (50% RH), and in area not exposed to direct sunlight. Vcc=7.25V, Ta=25°C, 50% Checkerboard. Software configuration follows Section 5.4 Initialization.
2	End of lifetime is specified as 50% of initial brightness. The average operating lifetime at room temperature is estimated by the accelerated operation at high temperature conditions.

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9 HANDLING PRECAUTIONS

9.1 HANDLING PRECAUTIONS

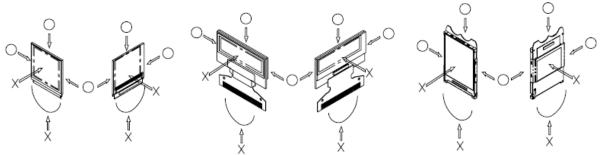
- 1) Since the display panel is being made of glass, do not apply mechanical impacts such us dropping from a high position.
- 2) If the display panel is broken by some accident and the internal organic substance leaks out, be careful not to inhale nor lick the organic substance.
- 3) If pressure is applied to the display surface or its neighborhood of the OEL display module, the cell structure may be damaged and be careful not to apply pressure to these sections.
- 4) The polarizer covering the surface of the OEL display module is soft and easily scratched. Please be careful when handling the OEL display module.
- 5) When the surface of the polarizer of the OEL display module has soil, clean the surface. It takes advantage of by using following adhesion tape.

* Scotch Mending Tape No. 810 or an equivalent

Never try to breathe upon the soiled surface nor wipe the surface using cloth containing solvent such as ethyl alcohol, since the surface of the polarizer will become cloudy.

Also, pay attention that the following liquid and solvent may spoil the polarizer: * Water

- * Ketone
- * Aromatic Solvents
- 6) Hold OEL display module very carefully when placing OEL display module into the system housing. Do not apply excessive stress or pressure to OEL display module. And, do not over bend the film with electrode pattern layouts. These stresses will influence the display performance. Also, secure sufficient rigidity for the outer cases.



- 7) Do not apply stress to the LSI chips and the surrounding molded sections.
- 8) Do not disassemble nor modify the OEL display module.
- 9) Do not apply input signals while the logic power is off.
- 10) Pay sufficient attention to the working environments when handing OEL display modules to prevent occurrence of element breakage accidents by static electricity.
 - * Be sure to make human body grounding when handling OEL display modules.
 - * Be sure to ground tools to use or assembly such as soldering irons.

* To suppress generation of static electricity, avoid carrying out assembly work under dry environments.

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* Protective film is being applied to the surface of the display panel of the OEL display module. Be careful since static electricity may be generated when exfoliating the protective film.

- 11) Protection film is being applied to the surface of the display panel and removes the protection film before assembling it. At this time, if the OEL display module has been stored for a long period of time, residue adhesive material of the protection film may remain on the surface of the display panel after removed of the film. In such case, remove the residue material by the method introduced in the above Section 5).
- 12) If electric current is applied when the OEL display module is being dewed or when it is placed under high humidity environments, the electrodes may be corroded and be careful to avoid the above.

9.2 STORAGE PRECAUTIONS

1) When storing OEL display modules, put them in static electricity preventive bags avoiding exposure to direct sun light nor to lights of fluorescent lamps, etc. and, also, avoiding high temperature and high humidity environments or low temperature (less

than 0° C) environments. (We recommend you to store these modules in the packaged state when they were shipped from Densitron Technologies Plc.) At that time, be careful not to let water drops adhere to the packages or bags nor let dewing occur with them.

2) If electric current is applied when water drops are adhering to the surface of the OEL display module, when the OEL display module is being dewed or when it is placed under high humidity environments, the electrodes may be corroded and be careful about the above.

9.3 DESIGNING PRECAUTIONS

- 1) The absolute maximum ratings are the ratings which cannot be exceeded for OEL display module, and if these values are exceeded, panel damage may be happen.
- 2) To prevent occurrence of malfunctioning by noise, pay attention to satisfy the VIL and VIH specifications and, at the same time, to make the signal line cable as short as possible.
- 3) We recommend you to install excess current preventive unit (fuses, etc.) to the power circuit (VDD). (Recommend value: 0.5A)
- 4) Pay sufficient attention to avoid occurrence of mutual noise interference with the neighboring devices.
- 5) As for EMI, take necessary measures on the equipment side basically.
- 6) When fastening the OEL display module, fasten the external plastic housing section.
- 7) If power supply to the OEL display module is forcibly shut down by such errors as taking out the main battery while the OEL display panel is in operation, we cannot guarantee the quality of this OEL display module.
- 8) The electric potential to be connected to the rear face of the IC chip should be as follows: US2066

* Connection (contact) to any other potential than the above may lead to rupture of the IC.

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9.4 OTHER PRECAUTIONS

- 1) When an OEL display module is operated for a long of time with fixed pattern may remain as an after image or slight contrast deviation may occur. Nonetheless, if the operation is interrupted and left unused for a while, normal state can be restored. Also, there will be no problem in the reliability of the module.
- 2) To protect OEL display modules from performance drops by static electricity rapture, etc., do not touch the following sections whenever possible while handling the OEL display modules.
 - * Pins and electrodes

* Pattern layouts such as the FPC

3) With this OEL display module, the OEL driver is being exposed. Generally speaking, semiconductor elements change their characteristics when light is radiated according to the principle of the solar battery. Consequently, if this OEL driver is exposed to light, malfunctioning may occur.

* Design the product and installation method so that the OEL driver may be shielded from light in actual usage.

* Design the product and installation method so that the OEL driver may be shielded from light during the inspection processes.

- 4) Although this OEL display module stores the operation state data by the commands and the indication data, when excessive external noise, etc. enters into the module, the internal status may be changed. It therefore is necessary to take appropriate measures to suppress noise generation or to protect from influences of noise on the system design.
- 5) We recommend you to construct its software to make periodical refreshment of the operation statuses (re-setting of the commands and re-transference of the display data) to cope with catastrophic noise.

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10 SUPPORTED ACCESSORIES

10.1 DUO KIT

Densitron has developed an easy to use yet powerful development and demonstration tool for driving its range of Passive Matrix OLED displays from the USB port of a PC. DUO (Densitron USB OLED) kit is hot pluggable and does not require extra cables or power supply to run, allowing users to be up and running in minutes.

The kit consists of an OLED display with transition Board, USB controller card, mini USB cable and a CD with software application and drivers.



Part number: PDK-N-2C16WE-1A

10.2 TRANSITION BOARD CARD

A Transition board card is like a daughterboard which is meant to be a circuit board for connections between the baseboards (DUO).

It has connector pins for interfacing between the display and the baseboards.

It also includes the OLED display.

Part number: PDT-N-2C16WE-1A

10.3 CONNECTOR BOARD CARD

A Connector board card is also a daughterboard which is a circuit board for connection between a microprocessor or microcontroller (customer's system). **Part number: EVK-CONNECT-029**

10.4 CONNECTORS

Type: hot bar soldering process No. of connections: 33 Pitch: 0.70mm

10.5 APPLICATION NOTES AND EXAMPLE CODES

On request to Densitron

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